**Overview**

The XMC-P2000E-SDI-VO board uses NVIDIA's advanced Quadro Pascal 14nm GPU technology. This rugged Pascal-based board includes support for flexible output interfaces, including 3G-SDI, DVI and analog outputs. The board can support up to three DisplayPort 1.4 outputs, which provides support for High Dynamic Range (HDR) video, and resolutions of 4K at 120Hz or 5K at 60Hz with 10-bit color depth.

The rugged XMC-P2000E-VO board includes air-cooled and conduction cooled options. For additional options contact WOLF to discuss MCOTS and custom design services.

**Key Features**

- NVIDIA GP107, 2.3 TFLOPS GPGPU Engine
- Chip-down rugged design, MIL-STD-810
- 4 independent outputs, includes up to 2x 3G-SDI, 1x analog (CVBS/STANAG 3350/VGA), 3x DisplayPort, 1x DVI-I
- 4 GB GDDR5 memory with NVIDIA GPDirect™ DMA
- Operating power default: 25W; configurable hard cap from 15 - 50W

**Additional Features**

- DisplayPort 1.4 digital video outputs:
  - support for High Dynamic Range (HDR) video
  - 4K at 120Hz or 5K at 60Hz with 10-bit color depth
- Pascal GPGPU parallel processing:
  - 768 CUDA® cores
  - CUDA Toolkit 9, CUDA Compute version 6.1
  - OpenCL™ 1.2, DirectX® 12, OpenGL 4.5, Vulkan 1.0
- Memory width: 128-bit
- Maximum memory bandwidth: 96 GB/s
- NVENC/NVDEC accelerator for HEVC (H.265) and AVC (H.264) hardware encode/decode
- PCIe x8 Gen3
- Windows and Linux drivers

**Specifications**

- High level of ruggedization:
  - Rugged air-cooled or conduction-cooled
  - Operating temperature: -40° to +85°C
  - Vibration (sine wave): 10G peak, 5 - 2000Hz
  - Shock: 30G peak for air-cooled, 40G peak for conduction-cooled
- Front I/O and Rear I/O configurations
- VITA 46.9 I/O compliant mapping for 3U and 6U VPX configurations
- Available with XMC 1.0 or XMC 2.0 configurations
Quadro Pascal GP107 is an enormous leap in processing power compared to the previous generation Maxwell GM107. It can provide up to 2.3 TFLOPS of CUDA processing at a very modest operating power, providing a huge improvement to 46 GFLOPS/Watt, making it an excellent choice for aerospace and defense applications. With its impressive processing power the board excels at data processing which benefits from advanced parallel processing, such as video stabilization, image processing, terrain analysis, object tracking or 3D visualization of geospatial data.

Quadro Pascal GPU architecture also provides a more powerful Unified Memory feature. Pascal’s larger virtual memory address space enable GPUs to access the entire system memory plus the memory of all GPUs in the system, while the on-demand page migration engine allows the system to migrate pages from anywhere in the system to the GPU’s memory for efficient processing. This improved memory handling results in significantly improved algorithm efficiency.
XMC-P2000E-SDI-VO

ORDERING CODES FOR XMC-P2000E-SDI-VO

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>317721-F00**XMCv10</td>
<td>Air cooled, XMC 1.0, Front IO: 2x 3G-SDI, 1x DVI-I, Rear: IO 2x DP++</td>
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<tr>
<td>317722-F00**XMCv10</td>
<td>Air cooled, XMC 2.0, Front IO: 2x 3G-SDI, 1x DVI-I, Rear: IO 2x DP++</td>
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<tr>
<td>317731-F00**XMCv10</td>
<td>Conduction cooled, XMC 1.0, Rear IO: 2x 3G-SDI, 3x DP++</td>
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<tr>
<td>317732-F00**XMCv10</td>
<td>Conduction cooled, XMC 2.0, Rear IO: 2x 3G-SDI, 3x DP++</td>
</tr>
</tbody>
</table>

** Contact Sales for full code definition. Code can specify: Conformal Coating, Modified Power Cap, Display Termination, other
Part Numbers shown for Standard I/O configuration, contact Sales for additional I/O configuration options

MANUFACTURING AND QUALITY ASSURANCE

WOLF designs modules to pass the following environmental standards:
- MIL-STD-810 (United States Military Standard for Environmental Engineering Considerations and Laboratory Tests)
- MIL-HDBK-217 (Reliability Prediction of Electronic Equipment)
- RTCA DO-160 (Environmental Conditions and Test Procedures for Airborne Equipment) on request

WOLF complies with the following quality management systems:
- ISO 9001:2015: Quality management systems (certified)
- SAE AS5553: Counterfeit Electronic Parts; Avoidance, Detection, Mitigation, and Disposition (compliant)
- SAE AS9100D: Quality Management System - Requirements for Aviation, Space and Defense Organizations (preparing for certification in 2019)

Boards are manufactured to meet the following standards:
- IPC-A-610 CLASS 3 (Acceptability of Electronic Assemblies)
- IPC 6012 CLASS 3 (Qualification and Performance Specification for Rigid Printed Boards, Class 3 for High Reliability Electronic Products)
- IPC J-STD-001 (Requirements for Soldered Electrical and Electronic Assemblies)